

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Baljit Ghotra</td> <td>09/17/2013</td> </tr> <tr> <td>Robert A. Skorge</td> <td>09/12/2013</td> </tr> <tr> <td>Marc D. Gunderson</td> <td>09/12/2013</td> </tr> <tr> <td>Barry J. Nagle</td> <td>09/13/2013</td> </tr> <tr> <td>Vincent R. Green</td> <td>09/12/2013</td> </tr> </tbody> </table>		Name	Execution Date	Baljit Ghotra	09/17/2013	Robert A. Skorge	09/12/2013	Marc D. Gunderson	09/12/2013	Barry J. Nagle	09/13/2013	Vincent R. Green	09/12/2013
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<table border="1"> <tr> <td>Name:</td> <td>Corn Products Development, Inc.</td> </tr> <tr> <td>Street Address:</td> <td>Av. Do Cafe, 277 - Torre B, 2 andar</td> </tr> <tr> <td>City:</td> <td>Jabaquara - Sao Paulo,</td> </tr> <tr> <td>State/Country:</td> <td>BRAZIL</td> </tr> <tr> <td>Postal Code:</td> <td>04311-000SP</td> </tr> </table>		Name:	Corn Products Development, Inc.	Street Address:	Av. Do Cafe, 277 - Torre B, 2 andar	City:	Jabaquara - Sao Paulo,	State/Country:	BRAZIL	Postal Code:	04311-000SP		
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CORRESPONDENCE DATA													
<p>Fax Number: 9087073706  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 908-575-6152        Email: patents@ingredion.com        Correspondent Name: Ingredion Incorporated        Address Line 1: Suite C        Address Line 2: 10 Finderne Avenue        Address Line 4: Bridgewater, NEW JERSEY 08807</p>													
ATTORNEY DOCKET NUMBER:	3406.NTR												
NAME OF SUBMITTER:	Thomas C. McKenzie, Ph.D.												

Signature:	/Thomas C. McKenzie/
Date:	09/18/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
<b>Total Attachments: 3</b> source=Ghotra_Assignment#page1.tif source=Three_Assignment#page1.tif source=Nagle_Assignment#page1.tif	

**ASSIGNMENT**

WE, Baljit Ghotra, Robert A. Skorge, Marc D. Gunderson, Barry J. Nagle, and Vincent R. Green

the true inventors of certain novel and useful inventions specified and claimed as

**HIGH TDF STARCH MADE BY HIGH TEMPERATURE STEEPING OF GRAIN**

in a provisional application for Letters Patent of the United States, which application was filed September 24, 2012, and assigned serial number 61/704,612 by the United States Patent Office, and the concurrently filed regular application,

have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over to

**Corn Products Development, Inc.**  
**Av. Do Café, 277 - Torre B, 2º andar**  
**Jabaquara - Sao Paulo, 04311-000SP**  
**BRAZIL**

and its successors and assigns,

for good and valuable **consideration**, the receipt of which is hereby acknowledged,

the **entire and exclusive right, title, and interest** in and to the inventions described in the application for Letters Patent, to the application for Letters Patent, and to the Letters Patent to be obtained from the application for said invention, and to any and all reissues, divisions, extensions, or continuations of any Letters Patent, and to any Letters Patent that may be applied for or granted for said invention in foreign countries,

and the entire and exclusive right to have and claim the priority of invention in all foreign countries, pursuant to the provisions of the International Convention for the Protection of Industrial Property, based on said application, including all rights to any accrued damages arising out of infringement during the time preceding and following grant of the Letters Patent and execution or recording of this assignment; and

we hereby request the Director of the United States Patent and Trademark Office to issue said Letters Patent to said Corn Products Development, Inc., its successors and assigns as the assignee of our interest; and

we hereby agree to execute any further papers necessary to secure said assignee in its full and complete enjoyment of its right to said invention, application, Letters Patent, reissues, divisions, extensions and continuations; and.

we hereby authorize the insertion of the serial number and filing date into this assignment upon notification by the United States Patent and Trademark Office.

Date: 09/17/2013 Sahil (BALJIT GHOTRA)

Date: \_\_\_\_\_

Date: \_\_\_\_\_

Date: \_\_\_\_\_

Date: \_\_\_\_\_

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Date: 9/12/2013 Marc D. Gunderson

Date: 9/12/2013 R. Skorge

Date: 9/12/2013 Baljit Ghotra

Date: \_\_\_\_\_

Date: \_\_\_\_\_

**PATENT**

**REEL: 031229 FRAME: 0660**

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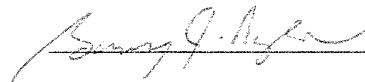
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Date: Sept. 13, 2013



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